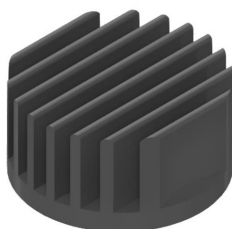


Data sheet Product ICK LED R 33 x 16,5

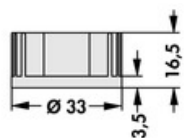
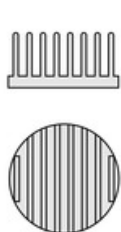


Heatsinks and active heatsinks for processors>Heatsinks for LEDs
Ø 33 x 16,5 mm, for IC design LED

Features

diameter:	33 mm
way of fixation:	• therm. conductive foil • therm. cond. adhesive
height:	16.5 mm
plate thickness:	3.5 mm
thermal resistance:	13.87 K/W
dissipation loss:	8.5 W
surface:	black anodised

Technical Drawing



$$R_{th} = 13,87 \text{ K/W}$$